Figure 1 Multi-Level Interconnection Architecture

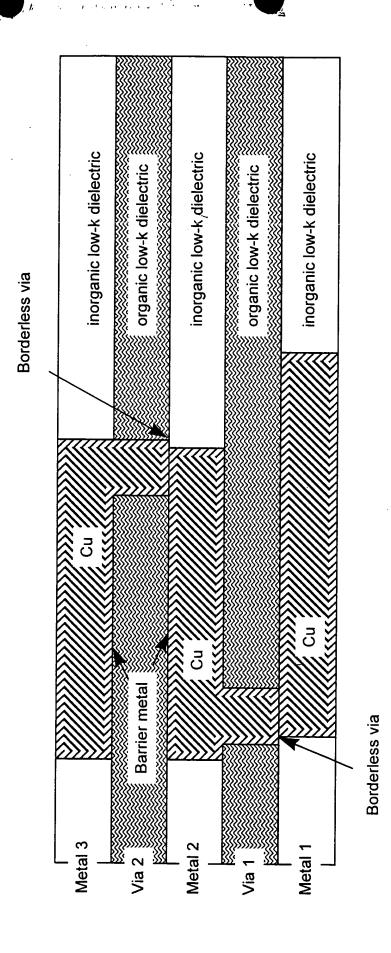


Figure 2 Multi-Level Interconnection Architecture II

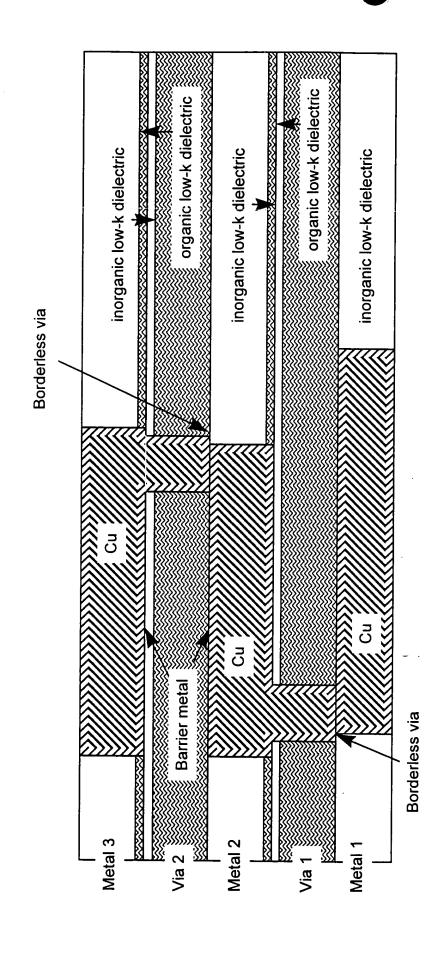
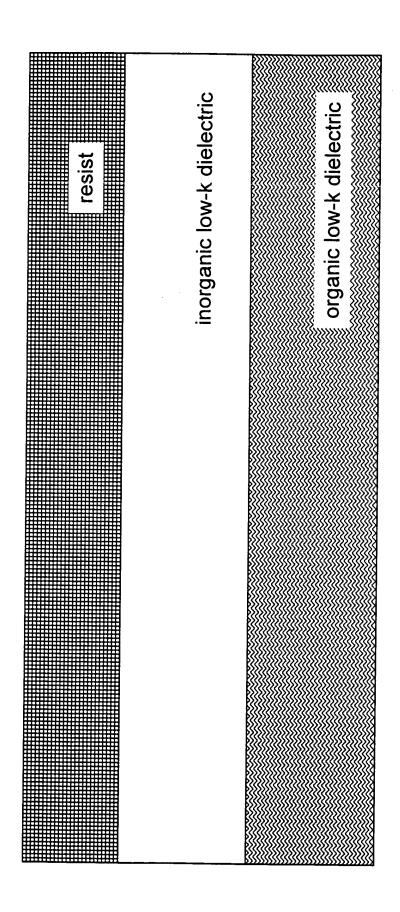


Figure 3
Step 1 Organic low-k dielectric deposition
Step 2 Inorganic low-k dielectric deposition
Step 3 Resist spin and bake



Step 4 Via mask and resist development Step 5 Metal trench inorganic low-k dielectric etch Figure 4

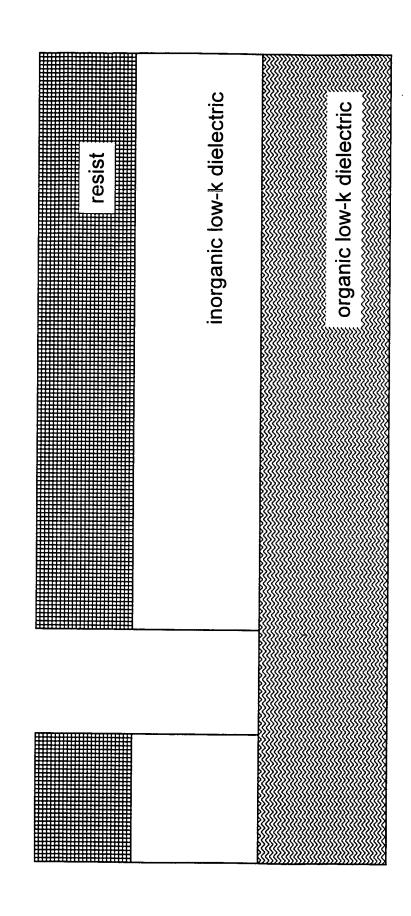


Figure 5 Step 6 Via organic low-k dielectric etch

Figure 6 Step 7 Resist spin and bake

inorganic low-k dielectric organic low-k dielectric resist

Figure 7 Step 8 Metal trench mask and resist development

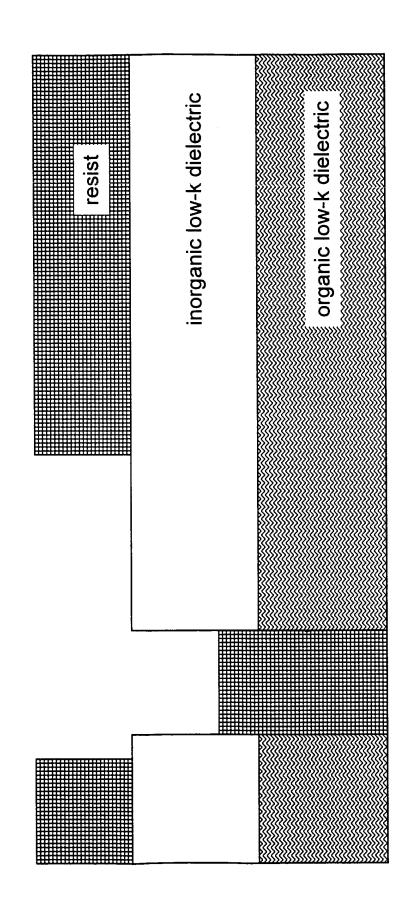


Figure 8 Step 9 Inorganic low-k dielectric etch

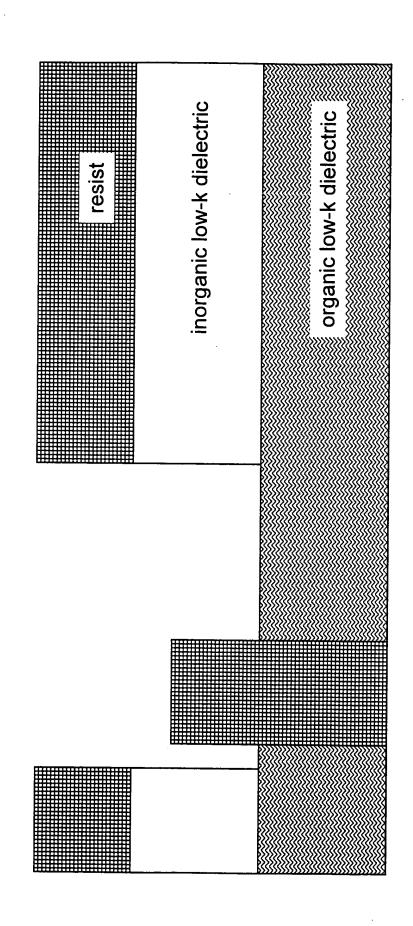


Figure 9

Step 10 Selective removal of resist

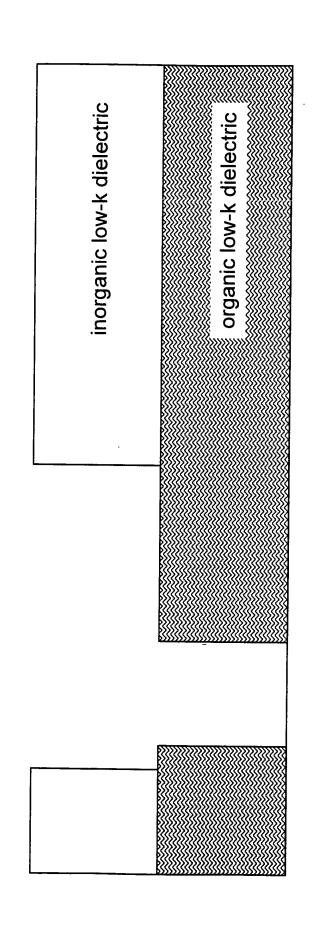


Figure 10

Step 11 Cu interconnect processing

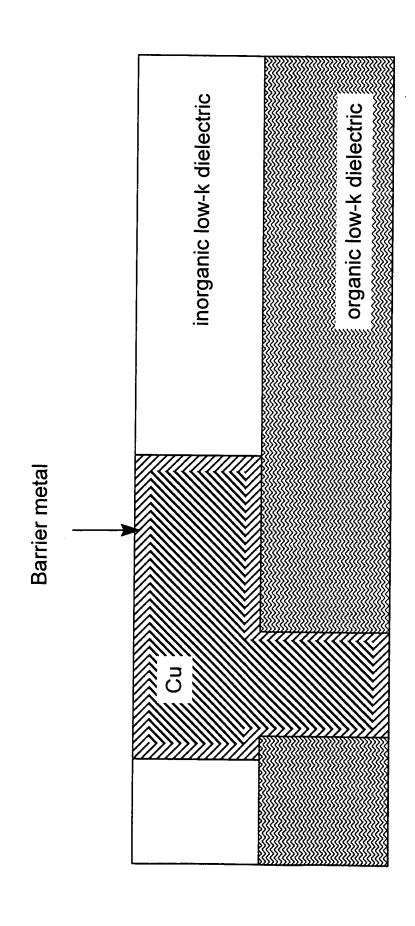


Figure 11

Step 1 Organic low-k dielectric deposition Step 2 Inorganic low-k dielectric deposition Step 3 Resist spin and bake

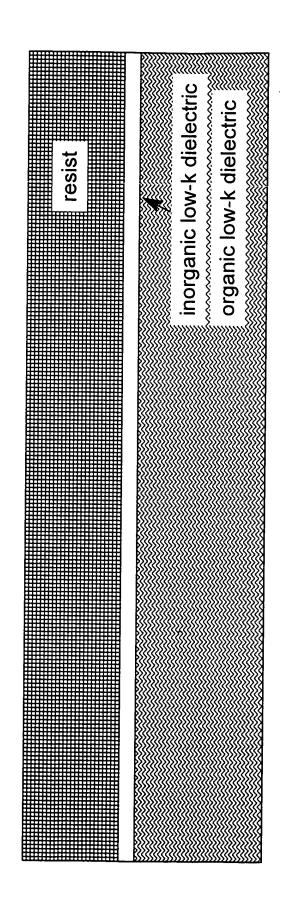


Figure 12

Step 4 Via mask and resist development Step 5 Inorganic low-k dielectric etch

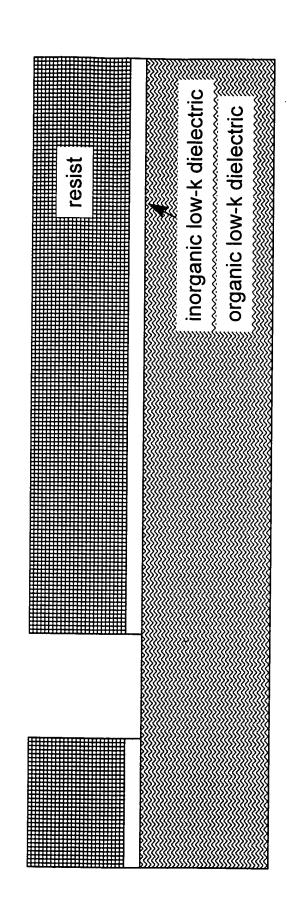


Figure 13

Step 6 Resist removal

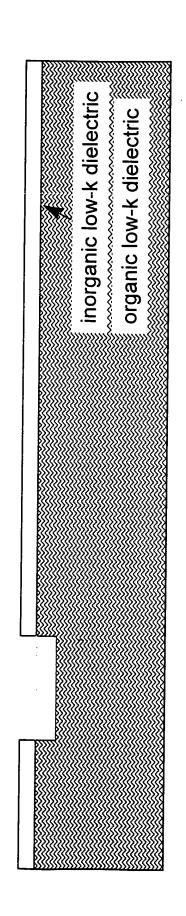
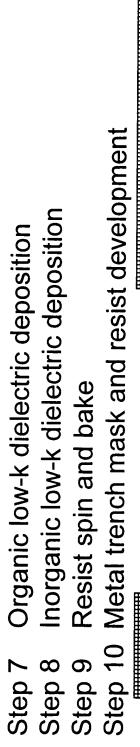


Figure 14



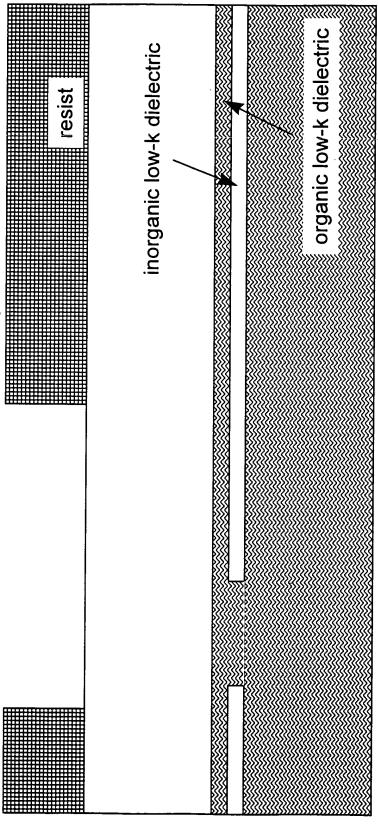


Figure 15

Step 11 Inorganic low-k dielectric etch

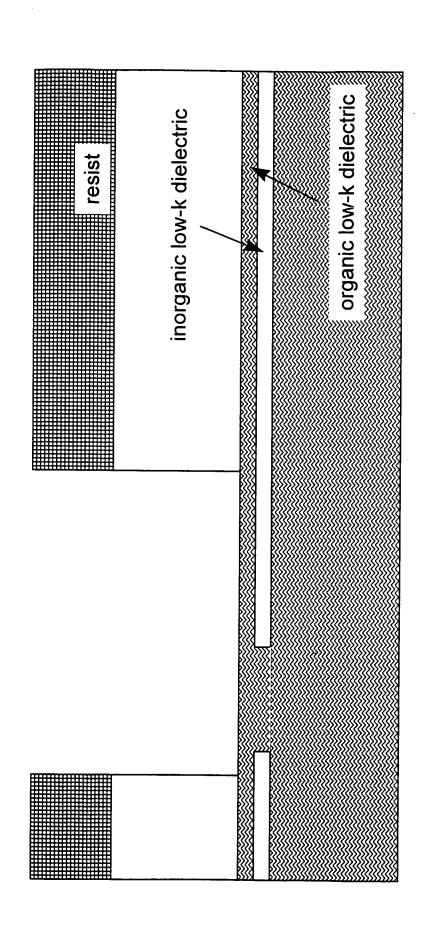


Figure 16

Step 12 Organic low-k dielectric etch

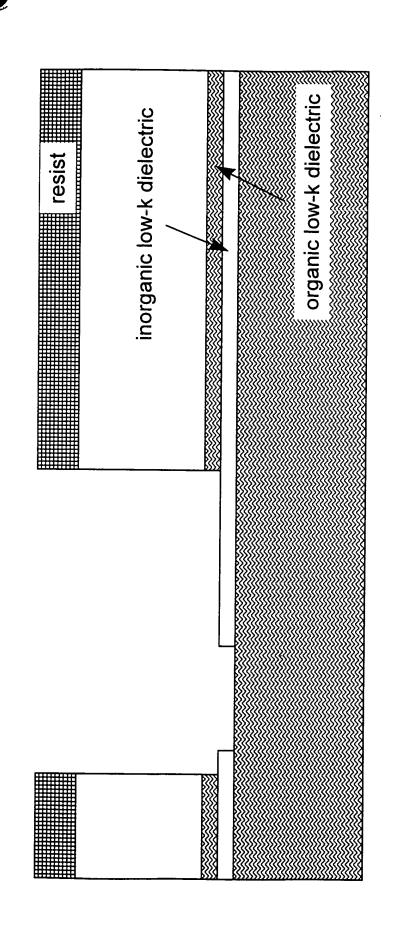


Figure 17

Step 13 Organic low-k dielectric etch

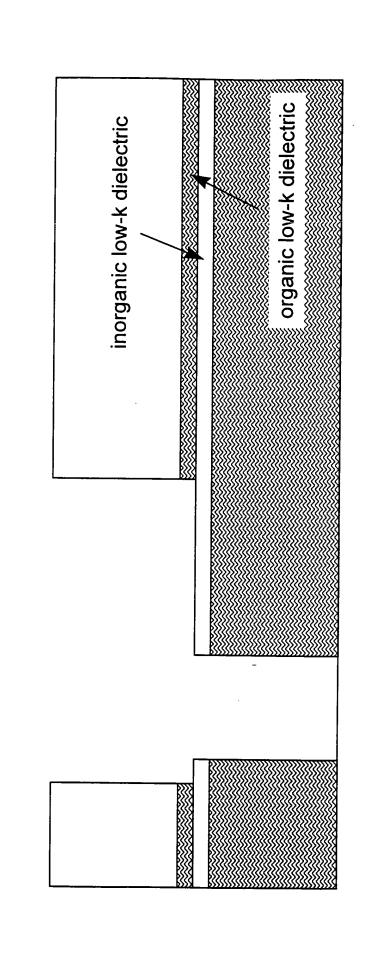
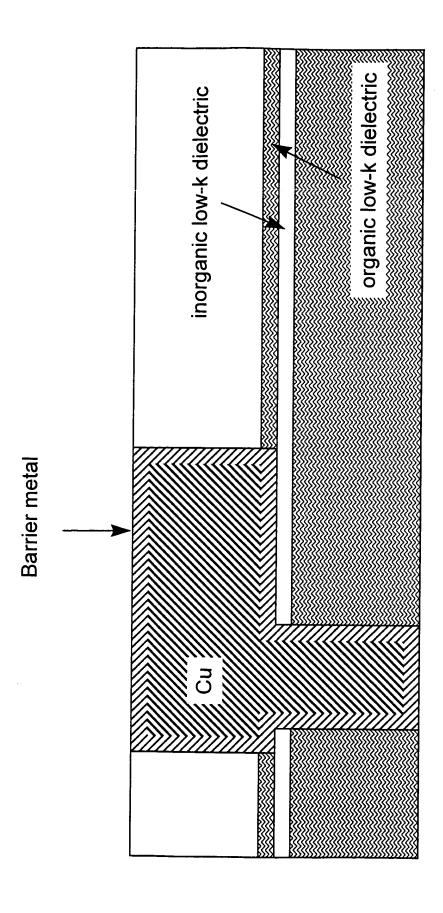


Figure 18

Step 14 Cu interconnect processing



Inorganic low-k dielectric deposition Inorganic low-k dielectric deposition Figure 19 Organic low-k dielectric deposition Organic low-k dielectric deposition Resist spin and bake Step 1 Step 2 Step 3 Step 4 Step 5

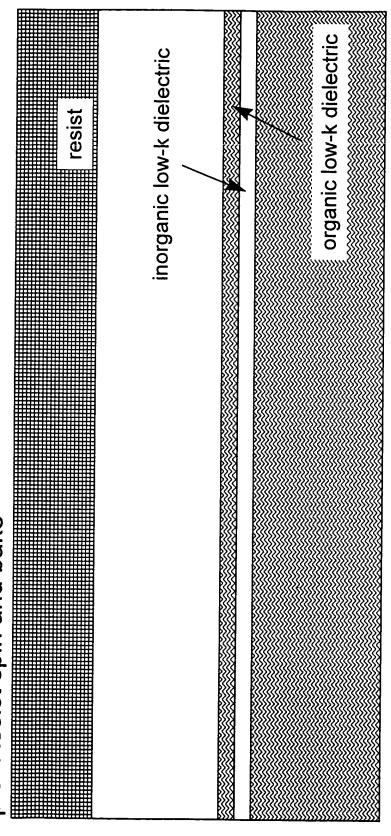


Figure 20

Step 6 Via mask and resist development Step 7 Inorganic low-k dielectric etch

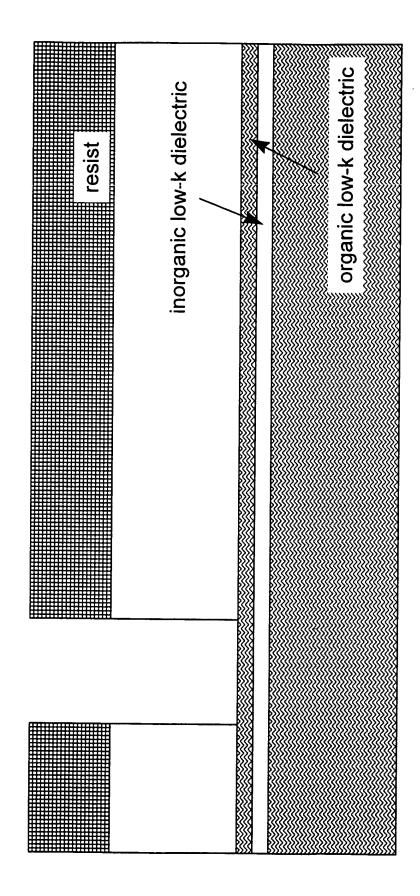


Figure 21

Step 8 Organic low-k dielectric etch Step 9 Inorganic low-k dielectric etch

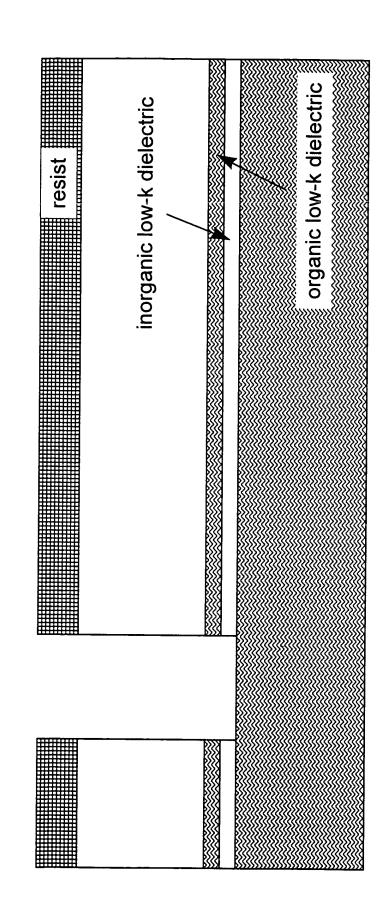


Figure 22

Step 10 Selective resist removal

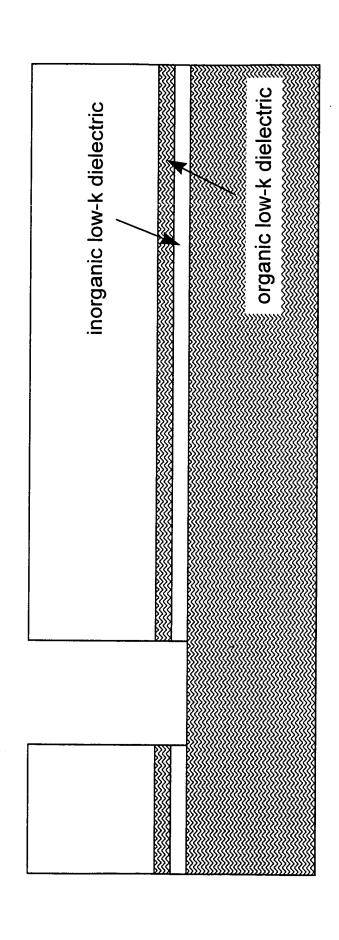


Figure 23

Step 11 Resist spin and bake

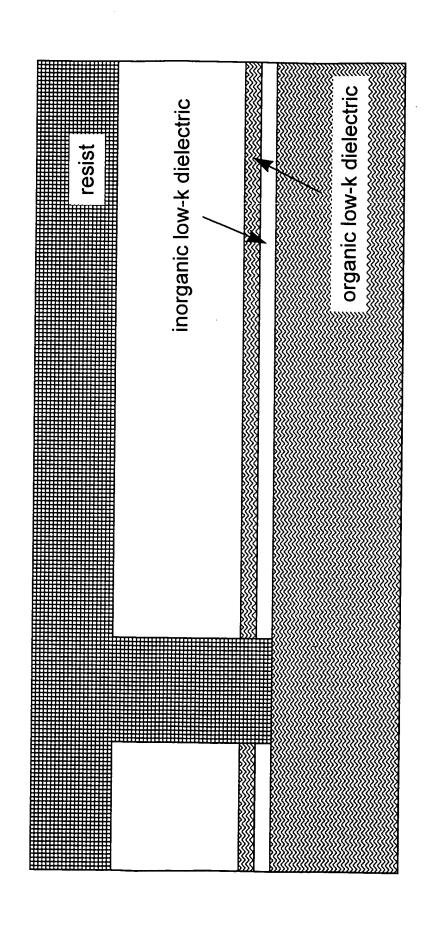


Figure 24

Step 12 Metal trench mask and resist development

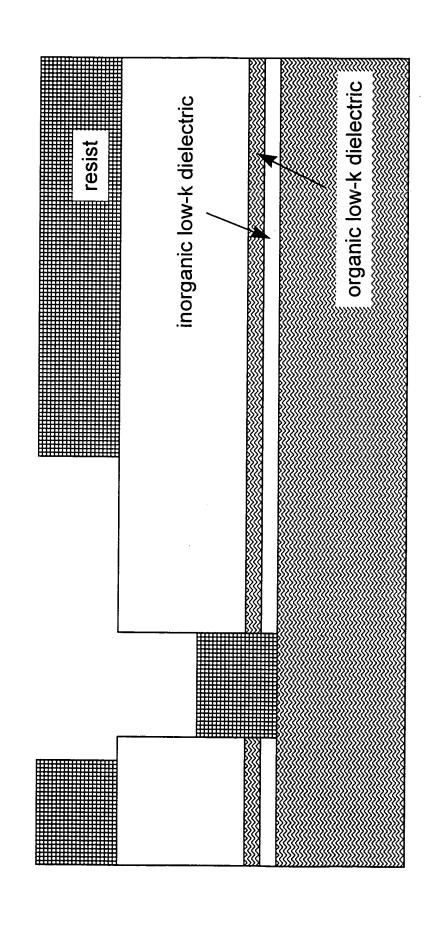


Figure 25

Step 13 Inorganic low-k dielectric etch

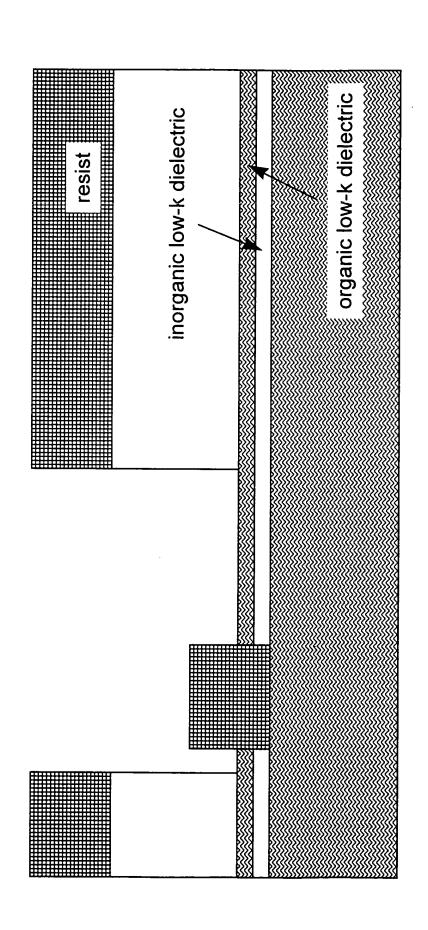


Figure 26

Step 14 Organic low-k dielectric etch

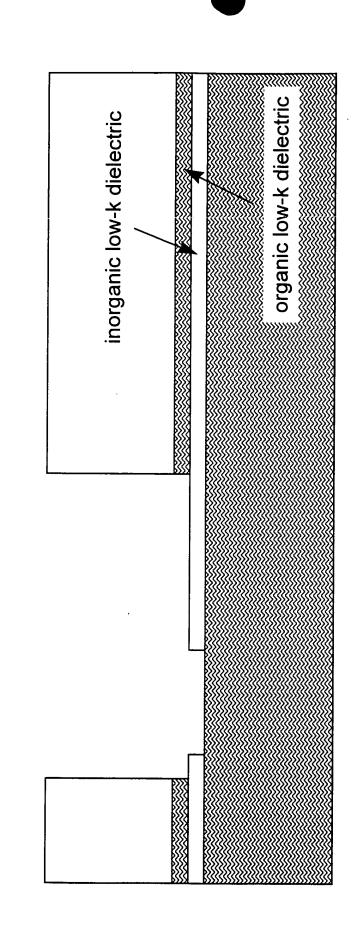


Figure 27

Step 15 Via inorganic low-k dielectric etch

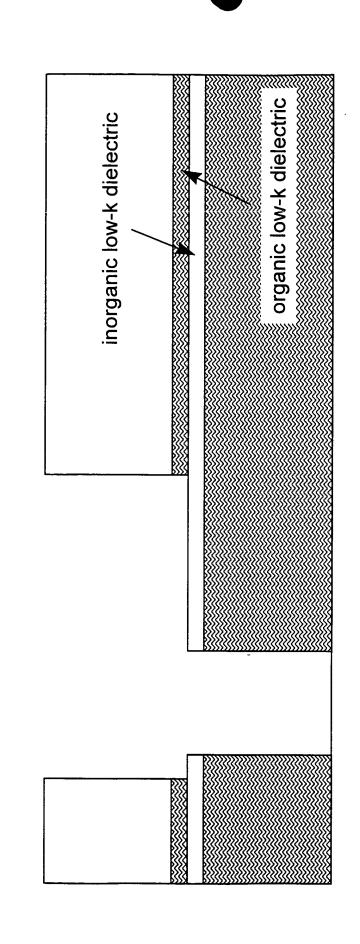


Figure 28

Step 10 Organic low-k dielectric etch

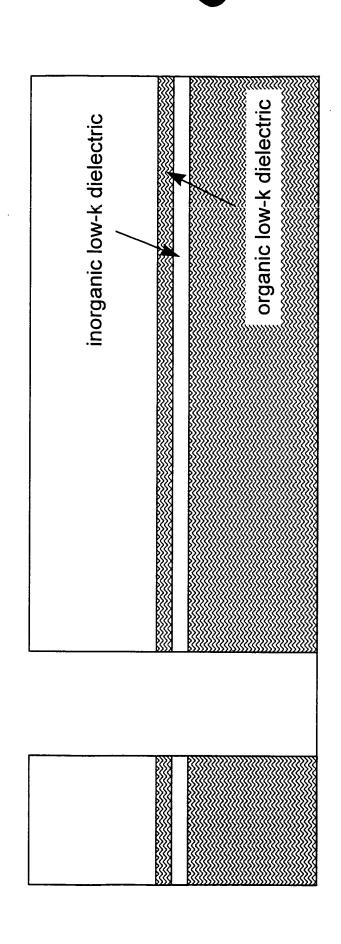


Figure 29

Step 11 Resist spin and bake

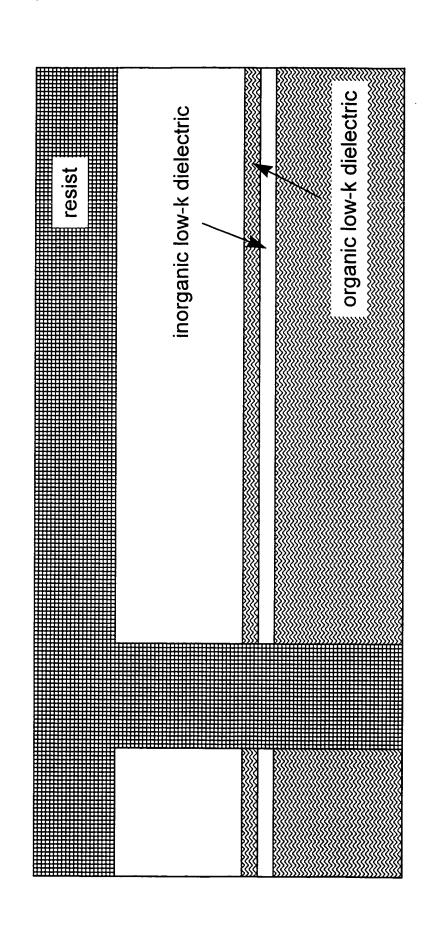


Figure 30

Step 12 Metal trench mask and resist development

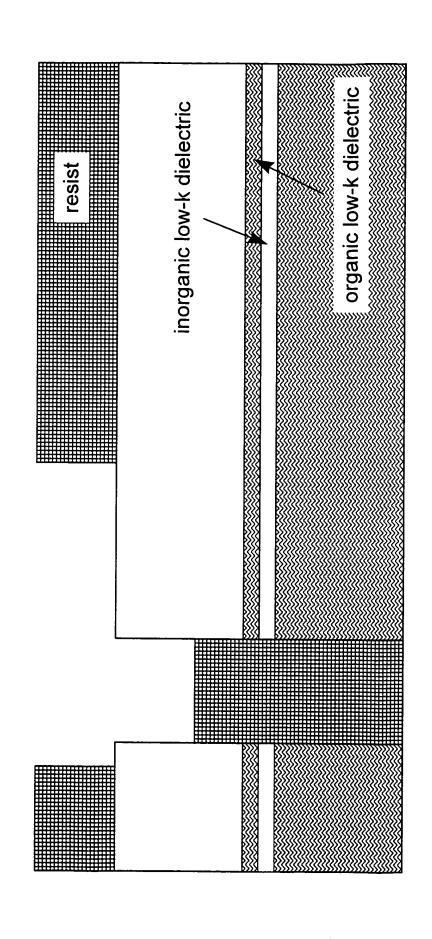


Figure 31

Step 13 Inorganic low-k dielectric etch

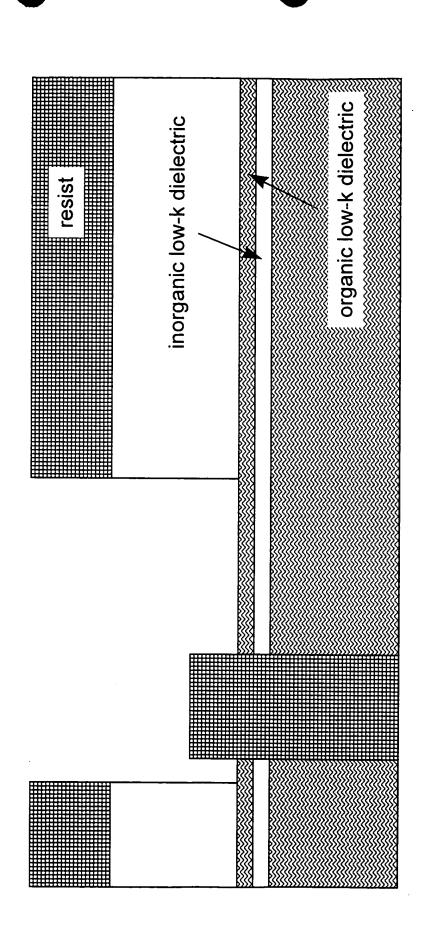


Figure 32

Step 14 Organic low-k dielectric and resist etch

